Spherical silicon photonic microcavities: From amorphous to polycrystalline

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Shaping silicon as a spherical object is not an obvious task, especially when the object size is in the micrometer range. This has the important consequence of transforming bare silicon material in a microcavity, so it is able to confine light efficiently. Here, we have explored the inside volume of such microcavities, both in their amorphous and in their polycrystalline versions. The synthesis method, which is based on chemical vapor deposition, causes amorphous microspheres to have a high content of hydrogen that produces an onionlike distributed porous core when the microspheres are crystallized by a fast annealing regime. This substantially influences the resonant modes. However, a slow crystallization regime does not yield pores, and produces higher-quality-factor resonances that could be fitted to the Mie theory. This allows the establishment of a procedure for obtaining size calibration standards with relative errors of the order of 0.1%.

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I. INTRODUCTION

Silicon microspheres constitute a promising platform for developing applications in many technological disciplines [1–5]. Their main strength stems from their capability to sustain optical resonances, i.e., of being photonic microcavities, and the fact that they are made of silicon, which is, among other things, the material basis of the current microelectronics industry. Silicon micro- and nanoparticles have been traditionally considered as a by-product in the context of thin film synthesis by chemical vapor deposition (CVD) [6,7]. For instance, one can read in silicon technology books [8] about the appearance of a sort of unwanted "silicon soot" during the synthesis of silicon by the Siemens method. However, in recent years silicon microspheres have received growing attention from researchers working in photonics and metamaterials [1-5,9-14]. At the same time, different fabrication methods have arisen [3,9,15-18].

The synthesis route based on CVD, using disilane (Si₂H₆) as a precursor gas [9], is very convenient because it allows the fabrication of both phases, amorphous and polycrystalline, due to the relatively low decomposition temperature (around 400 °C) of the precursor. In other words, amorphous microspheres can be synthesized at low decomposition temperatures (375 °-600 °C), while polycrystalline spheres can be produced by using higher process temperatures. Polycrystalline microspheres can also be obtained from their amorphous counterparts by a subsequent annealing process. However, the high hydrogen content of the precursor translates into the chemical composition of the microspheres, which may produce strong disturbances during the crystallization process in the form of voids, thus strongly influencing their optical and electrical properties. So far, the optical properties of such microspheres have been usually characterized by optical transmittance spectroscopy. This requires transferring them to a low refractive index substrate, such as glass. In this way, the optical resonance phenomenon was verified and the experimental peaks could be associated to Mie resonances [9,19]. This characterization has been accomplished for low size parameters (defined as $\pi d/\lambda$, where d is the sphere diameter and λ is the wavelength of light), where the resonant peaks are relatively wide and weakly influenced by any defects in the particles. However, the most recent applications based on this material [14], as well as any future development, require an in-depth structural and optical characterization. This is very important if we want to push silicon microspheres to a more prominent technological position, e.g., being integrated in photonic or optoelectronic chips, or in other fields such as medicine, where silicon microspheres have already been shown to be biocompatible [20] and potential active agents for cancer therapy [21].

Here we report a substantial step forward in characterizing and understanding the relation between structural and optical properties of such silicon microspheres. In particular we have studied the influence of the crystallization process on their internal structure and on their optical properties. This has required the development of techniques for measuring the optical resonances at higher size parameters, avoiding the influence of the substrate. Such resonances are more pronounced, i.e., with a higher quality factor, than those occurring at low size parameters. They are, therefore, much more sensitive to the defects in the material. The obtained results have revealed interesting opportunities for the development of applications. For instance, we have realized that a fast crystallization regime produces particles with a richly structured porous core, whereas a low-crystallization regime does not. Such porous core is not necessarily a drawback because, although it kills some resonances and might lead to a poor electrical quality, it can be utilized for future developments requiring the introduction of other substances into the pores. Also, it can be used to control (filter) the resonances present in the particle. Finally, the very small errors for the sphere diameter values obtained through fitting of the scattering spectra to Mie theory suggest proposing silicon microspheres as size calibration standards for microscopy.

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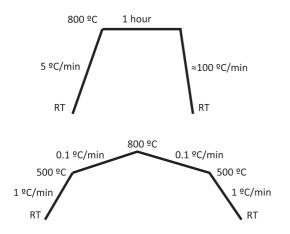


FIG. 1. Schematic of the two temperature profiles, fast (above) and slow (below), used for crystallizing amorphous silicon microspheres.

II. EXPERIMENT

A. Synthesis and crystallization processes of silicon microspheres

Silicon microspheres were synthesized by decomposing disilane gas (Si_2H_6) in a closed reactor under controlled conditions of pressure and temperature [9]. The process parameters were optimized for producing a thin layer of amorphous microspheres, with sizes in the range 1–4 μm , which are separated from one another [14]. This is very convenient because it allows us to identify them before and after any processing step, and optical measurements can be performed on single particles without manipulating them, as will be shown below. In all the cases, polished silicon slabs were used as carrier substrates onto which microspheres were directly synthesized and measured.

Amorphous silicon microspheres underwent different crystallization treatments at $800\,^{\circ}\text{C}$ using a homemade horizontal quartz tube furnace. First of all we performed a short dip in HF solution (1%) with the substrates containing the microspheres in order to remove the native oxide layer. Right after, the samples were introduced into the quartz tube, which was placed inside the tubular oven and the ambient was pumped out. Before the crystallization process, the samples were heated in vacuum at $200\,^{\circ}\text{C}$ during 1 h in order to remove any

traces of water. Then the quartz tube was filled with nitrogen, without breaking the vacuum, at a pressure of about 2 atm and the crystallization annealing was carried out. Two different crystallization regimes were studied: a fast one and a slow one, whose temperature profiles are detailed in Fig. 1.

In the fast regime, the samples were heated at a rate of 5 °C per minute up to 800 °C and they were kept at this temperature during 1 h. Then the process was abruptly stopped by removing the quartz tube from the tubular oven directly into the room temperature (RT) environment. This is the usual crystallization regime we had been using so far. In the slow regime, the samples were heated at a speed of 1 °C per minute up to 500 °C, and at 0.1 °C from this temperature up to 800 °C. Then the temperature decreased again to 500 °C at 0.1 °C per minute, and to RT from here at 1 °C per minute. These characteristics were chosen for allowing hydrogen degassing at the crystallization point, which we assumed to occur at a temperature around 600 °C [22,23]. In case of technological implementation of this method, more research could be focused on determining accurately the transition point and thus shorten the whole process.

B. Optical resonances characterization

Silicon microspheres yield optical resonances in the visible and near-infrared ranges, which have been measured so far by optical transmittance spectroscopy [9,19,24]. Here we report their detection by optical scattering at 90°. This technique has been used for measuring resonances in spherical cavities which are several tens of micrometers in size, for example, liquid droplets [25] and glass microspheres [26]. In our case, this approach is very advantageous because only those modes whose resonant plane occurs in the plane parallel to the substrate arrive at the detector. Here, this is of particular importance because the substrate is made of silicon and it is expected to kill the modes resonating in a plane crossing the substrate due to its high refractive index.

Figure 2 shows a scheme with the main elements of our measuring setup and, on the left side, a SEM image of a silicon microsphere placed on a substrate. The setup consists of a homemade confocal system where white light, indicated by the (red) gray areas, is focused onto a microsphere by a $20 \times$ objective lens with a NA of 0.4. The scattered light at 90° is collected by a similar objective and is focused on an

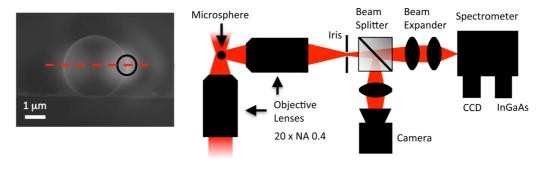


FIG. 2. Scheme of the setup used for measuring the light scattering at 90° of single silicon microspheres. The SEM image on the left side corresponds to a silicon microsphere lying on a substrate. The scattered light, as recorded by the camera, has been superimposed (light regions). The black circle indicates the area of the iris, projected on the microsphere, and the (red) dashed line indicates the position of the resonant plane for all the measured resonances.

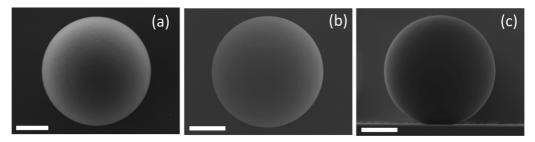


FIG. 3. FESEM images of a silicon microsphere (a) before, i.e., in the amorphous state (top view), and (b,c) after having been crystallized by using the fast regime (top and side view, respectively). The scale bars correspond to $1 \mu m$.

iris that allows passing only the light that exits the sphere tangentially within a limited area, which has been indicated in the SEM image by a black circle. This is an essential element for avoiding spurious light and improving the sensitivity of the system. However, it limits the detection to light coming from a particular area and direction, and some elements of the scattered light may be lost. This will be further commented on later in the framework of the obtained results. After having crossed the iris the light is divided by a beam splitter, where 10% of it goes to a camera for visualizing the position of the sphere and the scattered light. Such scattering effect, recorded by the camera, has been superimposed on the SEM image in the figure, corresponding to the light regions. The other 90% of the light transmitted through the beam splitter enters into a spectrometer (Horiba iHR320), with the help of a beam expander, where it is measured by means of both a liquid nitrogen refrigerated CCD two-dimensional (2D) array and an InGaAs one-dimensional (1D) array detector, for visible and near-infrared light, respectively.

All the measured spectra were corrected by the sensitivity of the system. For this purpose, the scattering produced by an unpolished silicon slab was used as a base curve. However, because the spectrometer sensitivity is highly dependent on the light polarization due to the diffraction gratings, and the particular polarization components of the scattered light are unpredictable, the corrected curves for the scattering spectra do not perfectly coincide with performed simulations as long as sensitivity is concerned, as will be shown below. On the other hand, these discrepancies arise mostly at the longest-wavelength region of the spectra, where the sensitivity of the InGaAs detector decreases substantially. We are currently studying possible solutions to these problems. They include, for instance, the usage of light diffusers after the beam expander.

C. Structural characterization

Structural properties of silicon microspheres were investigated by several electronic microscopy techniques. They include field emission scanning electron microscopy (FESEM) for external aspects such as sphericity and surface smoothness, and high-resolution transmission electron microscopy (HRTEM) for the internal structure. In the last case, microspheres were previously carved in planes perpendicular to the substrate, using a focused ion beam (FIB), until obtaining micelles (several tens of nanometers thick) of the central part of the microspheres.

III. RESULTS AND DISCUSSION

A. Influence of the crystallization regimes on the structural and optical properties of silicon microspheres: General observations

Amorphous silicon microspheres have very good conditions in terms of sphericity and surface smoothness; see for example Fig. 3(a). These features, together with the high refractive index of silicon, are very promising for sustaining high quality factor (Q) optical resonances, where Q can be calculated as the ratio between the resonant wavelength, λ , and the peak's full width at half maximum, $\delta \lambda$; $Q = \lambda / \delta \lambda$. Because of these reasons, optical scattering spectra of amorphous silicon microspheres include many pronounced peaks whose origin is the optical resonance phenomena, as shown by the bottom curves of Figs. 4(a) and 4(b). They correspond to Q values of the order of 1000. This value, however, is limited by the resolution and the sensitivity of the detection system and there may exist unmeasured higher-Q resonances beyond the resolution of the spectrometer. We will comment more in detail in the next section. In any case, as expected, the high-Q resonances disappear for wavelengths approaching the visible range because of the absorption of the material.

The crystallization processes, under the conditions specified in Sec. II A, preserved the surface smoothness and the spherical shape of the particles for both regimes of crystallization. Figure 3 shows FESEM images of the same microsphere before (a) (top view), and after having been crystallized by the fast regime (b) (top view) and (c) (side view). We did not find any conclusive difference before and after the crystallization processes for these features within the limitation of the microscope resolution. However, in general we observed a decrease of the sphere diameter, about 5% of the initial value, in the case of microspheres treated by using the slow crystallization regime. Table I shows the diameter of several microspheres before and after crystallization by the slow regime. The values shown in the second and third columns correspond to diameters obtained from FESEM images. The last column shows the diameters of the same crystallized microspheres obtained by fitting their scattering spectra to Mie theory. This will be further discussed in the next section.

Contrary to the structural properties of the surface, which remained unchanged, the optical scattering spectra of amorphous silicon microspheres were substantially modified after the crystallization processes. Figure 4(a) shows two spectra of a microsphere, about 3300 nm in diameter, before (bottom curve) and after (top curve) having been crystallized following the fast regime. This crystallization regime produces the

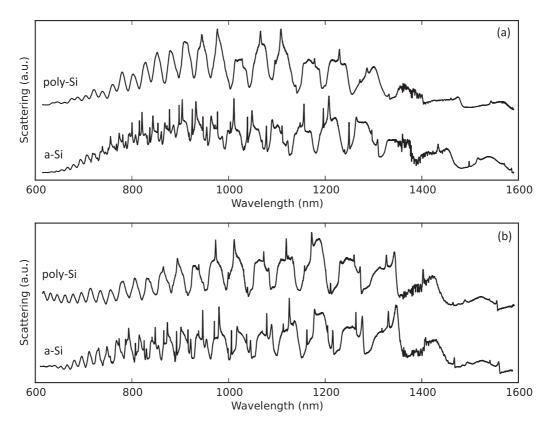


FIG. 4. (a) Scattering spectra of a silicon microsphere in the amorphous state (bottom curve) and after having been treated by the fast crystallization regime (top curve). (b) Same as (a), but for the slow crystallization regime.

disappearance of the sharp resonances. Only a coarse ripple structure and some relatively low Q value (say about 300) resonant modes still remain in the scattering spectrum. Some differences between these curves could be expected in relation to the refractive index difference between amorphous and crystalline silicon, but not the disappearance of the sharp peaks. On the other hand, the slow crystallization regime was found to preserve higher-Q modes, as is shown by Fig. 4(b) for sphere 6 in Table I. The difference between these two crystallization regimes must be, therefore, related to internal structure differences between the particles, as we will prove later through TEM imaging.

TABLE I. Diameter values in nm of several silicon microspheres before (amorphous) and after (crystallized) annealing by the slow regime. The second and third columns represent the values as measured from their FESEM images. The last column shows the diameters of the crystallized microspheres as obtained from the fit of their optical scattering spectra to Mie theory.

Sphere number	Amorphous (FESEM)	Crystallized (FESEM)	Crystallized (fitting)
1	2810 ± 20	2670 ± 20	2681 ± 5
2	2940 ± 20	2820 ± 20	2801 ± 6
3	2520 ± 20	2410 ± 20	2406 ± 6
4	2690 ± 20	2550 ± 20	2555 ± 7
5	2930 ± 20	2780 ± 20	2786 ± 6
6	2970 ± 20	2810 ± 20	2826 ± 6
7	2800 ± 20	2670 ± 20	2676 ± 6
8	3610 ± 20	3410 ± 20	3430 ± 5

B. Mie theory fit of spectra

1. Amorphous silicon microspheres

Optical scattering spectra of amorphous silicon microspheres were fitted to theoretical spectra, calculated by Mie theory [27]. For this purpose we used the subroutines by Barber [28], for calculating the scattering of light by a spherical particle at 90°, and corrected the spectra to account for the NA of the objective lenses. The sphere diameter values measured by FESEM (Table I) were considered as starting parameters. Because of the uncertainty on the exact dispersion curve for amorphous silicon, which depends on the fabrication conditions, the refractive index was also adjusted along the fitting process at several points in intervals of 100 nm, assuming linearly interpolated values between them.

Figure 5 shows the good agreement obtained between the experimental (black curve) and the simulated [(red) gray curve] scattering spectrum for sphere 6 of Table I, considering arbitrary values of offset and contrast so that the two curves overlap. Figure 6 corresponds to a closeup of the spectral region of Fig. 5 showing in more detail a few typical resonances. They have been labeled using the common notation [29] by letters "b" and "a" for transversal electric and transversal magnetic modes, respectively, followed by two indices: the mode number, which indicates the number of electric field intensity maxima in the half sphere perimeter, and the order of the resonance, which accounts for the number of maxima in the radial direction, respectively. The discrepancies in intensity and contrast between the simulated and the experimental spectra may have different causes, such

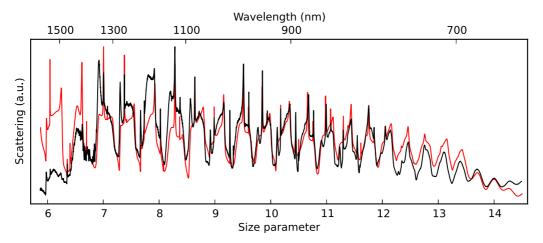


FIG. 5. Experimental (black curve), and simulated [(red) gray curve] spectra for microsphere 6 of Table I in the amorphous state. The spectra are plotted against the wavelength of light, λ (top axis), and the size parameter (bottom axis), defined as $\pi d/\lambda$, where d is the sphere diameter.

as the uncertainty in the sensitivity correction (see Sec. II B) and the fact that the scattered light is measured in a reduced area at the microsphere's edge (see the black circle on the SEM image of Fig. 2), and some components may be poorly detected, thus highlighting others. This could be the case, for instance, of resonance $a_{12.5}$.

The resulting fitted real part of the refractive index, n_r , is shown in Fig. 7 (black curve and points). Here, the error bars were calculated by fitting the scattering spectrum for the minimum and the maximum diameter values given by the error of the diameter (see second column in Table I). Furthermore, all the microspheres of Table I yielded refractive index values within these error bars. It is interesting to compare these values with others reported in the literature. We found that the refractive index dispersion of our amorphous silicon microspheres is very similar to that of hydrogenated microcrystalline silicon thin films reported by Badran et al. [30], obtained by plasma enhanced chemical vapor deposition. The agreement is best for those samples with low crystalline volume fraction. The (red) dashed curve corresponds to their sample 5, which had a crystalline volume fraction of 68%. These values are, however, much lower than other reference values of the refractive index collected by Palik [31], such as those of Pierce et al. [32]

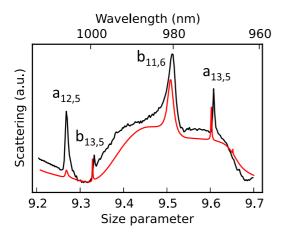


FIG. 6. Reduced range of Fig. 5, where some typical resonances are indicated.

(blue) dotted curve. This is not contradictory because there should be a substantial difference in the hydrogen content, which strongly depends on the synthesis method used.

The imaginary part of the refractive index, n_i , originates from light absorption losses in the material but it can also include other spurious scattering effects such as surface roughness and defects. Therefore, n_i strongly influences both the height and width of the resonant peaks. In general, the higher the n_i the lower the scattering height, since light gets resonantly absorbed rather than scattered, and the wider the resonance, due to the reduced Q. Eventually, for very high n_i values the resonances get killed [33]. The fit of Fig. 5 was achieved by considering n_i values of 0.06, 0.004, and 0.0001 for wavelengths of 600, 700, and 800 nm, respectively, with linear interpolation between these points, and an arbitrary constant value of 0.0001 for wavelengths higher than 800 nm. These values, however, should be considered as a qualitative approach because of the limited resolution, around 1 nm, of the measurement, what imposes a limit to the highest measurable Q of about 1000.

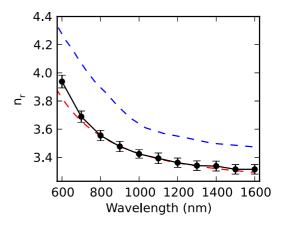


FIG. 7. Real part of the refractive index dispersion utilized for fitting the scattering spectra of Fig. 5 (black curve and points). Other refractive index values corresponding to amorphous silicon reported in Refs. [30,32], have been plotted for comparison as (red) dashed and (blue) dotted curves, respectively.

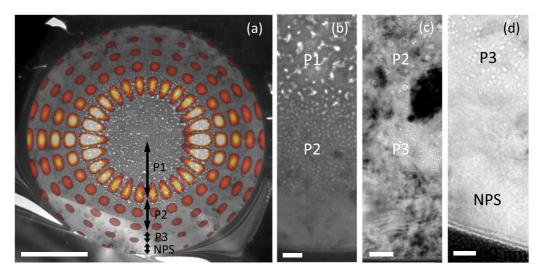


FIG. 8. (a) HRTEM image of the internal surface of a fast crystallized silicon microsphere, superimposed by the electric field intensity distribution of mode $b_{13,5}$. The positions of the different porous regions, P1, P2, and P3, as well as the nonporous shell (NPS) are indicated. (b) Zoomed area of (a) for better visualizing the transition between P1 and P2. (c,d) Higher-magnification images illustrating the transition between P2-P3 and P3-NPS, respectively. The scale bars correspond to 1 μ m (a), 100 nm (b), 50 nm (c), and 20 nm (d).

2. Crystallized silicon microspheres

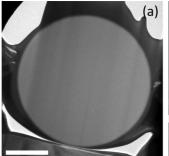
Figure 4(a) shows how most of the pronounced peaks disappeared from the scattering spectrum after the fast crystallization process. Such disappearing peaks correspond to Mie resonances with high order numbers, i.e., modes with several electric field intensity maxima in the radial direction, as has been shown in Fig. 6. They are well distributed inside the microspheres; therefore, in the absence of surface defects, structural defects localized inside them are expected to strongly influence such resonances, effectively killing them. This hypothesis was confirmed by the structural measurements of the inner part of the microspheres. Figure 8(a) shows a HRTEM image of the internal structure of a fast crystallized sphere of about 3.5 μ m in diameter superimposed, as an example, by the electric field intensity distribution of mode $b_{13.5}$. As can be observed in the image, the fast crystallization process produces an inner porous structure surrounded by a nonporous shell (NPS). The existence of pores inside crystallized silicon microspheres had already been reported [14], but it had not been studied in as much detail as we do here. The pore-size distribution is highly dependent on the radial direction and can be divided into three parts, indicated in the figure as P1, P2, and P3. Figure 8(b) corresponds to a zoomed area of Fig. 8(a), and Figs. 8(c) and 8(d) are higher magnification images that allow a better visualization of such porous regions, as well as the transitions between them. The innermost part, contained within a radius of 1 μ m (P1 region), has pores with undefined shape, and size in the range of 100 nm. It follows a thick shell of about 500 nm with round pores of size in the range of 10 nm (P2 region), and another 100-nm-thick shell with pores of a typical size of 1 nm (P3 region). Finally, as mentioned above, the outermost layer (NPS) is nonporous, and its thickness is about 100 nm.

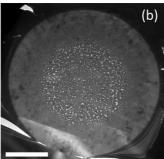
In spite of the internal porous structure, the FESEM images of the outside aspect [Figs. 3(b) and 3(c)] of the NPS show it is highly spherical and has a smooth surface. Therefore, although modes, such as $b_{13.5}$, are killed by the porous structure, other

types of resonances, which are more localized near the NPS and at the microsphere's surface, such as those with high number and low order mode, could in principle resonate. Our scattering setup has not been able to detect such high-Q modes, but they could be detected by more sensitive approaches. Moreover, they might be the origin of the rich absorption spectra observed by measuring the electronic response in crystallized and doped silicon microspheres [14]. This would prove, at the same time, the high sensitivity of this technique, consisting of measuring absolute absorption (photocurrent) rather than scattering at a defined angle.

The origin of such a porous structure currently constitutes a subject of research. Nevertheless, here we hypothesize that it may be originated from the high content of hydrogen in the as-synthesized amorphous silicon microspheres, which comes from the precursor gas, Si_2H_6 . If the crystallization process is relatively fast, the outermost shell of an amorphous particle crystallizes before the hydrogen from inside the particle can be degassed. As a result, the remaining hydrogen may evolve into bubbles during the atomic rearrangement. We believe that the size of the pores is related to the amount of trapped hydrogen and to the particle formation process, where micrometer-size particles are formed by coalescence of smaller ones [34], in a similar manner to what happens with colloidal synthesis of SiO_2 by the Stöber method in liquid suspensions [35].

In contrast to the observed porous structure in fast crystallized silicon microspheres, the inside surface of an amorphous silicon microsphere is very smooth and free of pores and defects [see Fig. 9(a)]. Therefore it constitutes, in principle, a much more suited platform for observing high-Q resonant phenomena. Figure 9(b) shows again the inside structure of the fast crystallized microsphere for comparison. On the other hand, the slow crystallization process preserves the pronounced resonances in the scattering spectra much better than the fast crystallization regime [see Figs. 4(a) and 4(b)]. The observation of the inside structure of slowly crystallized microspheres revealed that this fact is related to the suppression





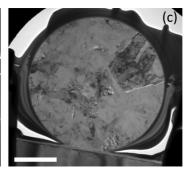


FIG. 9. HRTEM images of the inside surface of amorphous (a), and polycrystalline silicon microspheres obtained by the fast (b) and the slow (c) crystallization regimes. The scale bars correspond to $1 \mu m$.

of pores [see Fig. 9(c)]. Indeed, the slow heating process should favor an easier release of hydrogen from the inner part of the particles, thus allowing a better reorganization of the silicon atoms in the crystal lattice. However, other defects like those related to the finite size of the crystal domains, which can be guessed by the uniform grayed areas, are still present.

The scattering spectra of slowly crystallized microspheres could be fitted fairly well to simulations given by Mie theory. In this case, in contrast to the amorphous case, only the sphere diameter was considered as a fitting parameter because the refractive index values of crystalline silicon do not depend on the fabrication method. Figure 10 is an example of such a fit for sphere 6 of Table I. We used, for the real part of the refractive index, values compiled by Palik [31] in the wavelength range from 500 to 1200 nm, and values compiled by Li [36] from 1200 to 1600 nm. Regarding the imaginary part, we used the values reported by Braunstein et al. [37] for intrinsic silicon for wavelengths shorter than 1150 nm, assuming a value of zero for longer wavelengths. This causes, logically, many high-Q resonances to appear in the simulated curve at the longest-wavelength region, where no absorption is considered, but they cannot be detected experimentally because of the same setup limitations explained above for the case of amorphous microspheres. Still, such high-Q resonances might be there and would be influenced by the structural defects as well and, therefore, should be further investigated with the appropriate techniques. In any case, the assumption of standard refractive index values led to fits of sphere diameters with very small errors, of the order of several nanometers (fourth column in Table I), which correspond to remarkable relative errors of about 0.1%. These errors are originated from the small deviations in the position between the simulated and the experimental peaks that occur at a given diameter value. They were calculated as the difference between the maximum and the minimum diameter that is required for any simulated resonance of the spectrum to match its corresponding experimental peak. This is in contrast to the much bigger errors, obtained from electron microscopy images (third column in Table I), and it is an order of magnitude smaller than the usual size dispersion of the particles used for size calibration purposes. Therefore, crystallized silicon microspheres, together with the reported optical scattering characterization method plus the fitting process to Mie theory, could find application as accurate size calibration standards.

IV. CONCLUSIONS

Silicon microspheres behave as optical microcavities in their amorphous as well as in their polycrystalline phase because of their good spherical condition, surface smoothness, and the high refractive index of the material. Optical scattering at 90° has been proven to be a very convenient technique

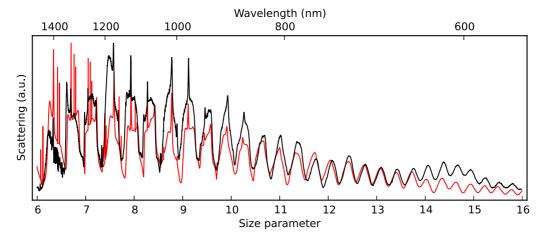


FIG. 10. Experimental (black curve) and simulated [(red) gray curve] spectra for microsphere 6 of Table I in the crystalline state. The spectra are plotted against the wavelength of light, λ (top axis), and the size parameter (bottom axis), defined as $\pi d/\lambda$, where d is the sphere diameter.

to measure and analyze their resonances. Two regimes of crystallization were studied, a fast one and a slow one, and no conclusive external changes, regarding sphericity and surface smoothness, were observed between the amorphous and the crystalline particles. However, we found substantial differences in their optical scattering spectra, which were attributed to changes in their internal structure. Fast crystallized microspheres have an internal radially distributed porous structure, with pore sizes in the range from 100 to 1 nm, surrounded by a nonporous shell. This makes those high-Q resonances, whose electromagnetic field is well distributed along the porous regions, fade out. On the other hand slowly crystallized microspheres did not show any pores and could better sustain pronounced modes. In both cases, they have defects related to their polycrystalline nature that can diminish the quality of the resonances. The scattering

spectra of amorphous and crystallized microspheres could be fitted fairly well to simulated spectra obtained by applying Mie theory, and remarkable errors of about 0.1%, below the error obtained through FESEM imaging, were obtained for the fitted diameters in the last case.

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